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Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	3	((("6498400") or ("6489678") or ("4661192")).PN.	US-PGPUB; USPAT	OR	OFF	2005/06/24 10:55
S2	111886	circuit adj element	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/24 10:55
S3	15015	S2 and (circuit adj board)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/24 10:56
S4	328	S3 and (conductive adj epoxy)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/24 11:06
S5	222	S2 and underfill	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/24 11:07
S6	157	S5 and (flip adj chip)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/24 11:10
S7	450	(156/314).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/06/24 11:10
S8	43	("3561107"   "3651448"   "3871014"   "3972062"   "4021838"   "4604644"   "5075965"   "5311402"   "5313366"   "5326932"   "5367435"   "5381039"   "5394490"   "5397921"   "5447886"   "5448114"   "5454160"   "5477087"   "5504372"   "5510758"   "5512786"   "5532512"   "5642262"   "5654590"   "5703405"   "5726501"   "5726502"   "5729440"   "5734201"   "5739585"   "5821617"   "6084308").PN. OR ("6489678").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/27 10:16

S9	4	("4624724"   "5538771"   "5614316"   "5670251").PN. OR ("6498400"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/27 10:24
S10	121	("3292240"   "3303393"   "3373481"   "3429040"   "4074342"   "4285002"   "4457796"   "T955008").PN. OR ("4661192"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/27 10:24
S11	19	("3795047"   "3955024"   "4157932"   "4242157"   "4269759"   "4442966"   "4483889"   "4578215"   "4661192"   "4811081"   "4818823"   "5261156"   "5296063"   "5372750"   "5463190"   "5611884"   "5842273"   "5879965").PN. OR ("6590285"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/27 11:31
S12	21	("3795047"   "3955024"   "4157932"   "4242157"   "4269759"   "4442966"   "4483889"   "4578215"   "4661192"   "4811081"   "4818823"   "5261156"   "5296063"   "5372750"   "5463190"   "5611884"   "5842273"   "5879965").PN. OR ("6589376"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/27 11:34
S13	20	(conductive adj epoxy) and (underfill adj encapsulant)	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/27 11:43
S14	377	(conductive adj epoxy) and underfill	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/27 13:53
S15	241	capacitor and resistor and diode and transistor and inductor	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/27 14:25
S16	1413	(438/118).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/06/28 06:45
S17	309	S16 and (conductive adj (epoxy or adhesive))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/27 15:05
S18	7	resistor near (conductive adj (epoxy or adhesive))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/27 15:28

JUB

S19	453	resistor near bond\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/27 15:28
S20	347	(438/119).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/06/28 06:45
S21	2317	(257/778).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/06/28 07:36
S22	496	S21 and (conductive adj (epoxy or adhesive))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/28 08:07
S23	158	S22 and (capacitor or resistor or diode or transistor or inductor)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/28 08:14
S24	2243	bond\$4 near (capacitor or resistor or diode or transistor or inductor)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/28 08:18
S25	445	S24 and (circuit adj board)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/28 08:26
S26	4721	(circuit adj elements) near (capacitor or resistor or diode or transistor or inductor)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/28 08:20
S27	878	S26 and (circuit adj board)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/28 08:21
S28	82	S25 and (conductive adj (adhesive or epoxy))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/28 08:27

JLB

S29	11	S21 and S24	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/28 08:38
S30	595	bond\$4 near (resistor or inductor)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/28 08:38
S31	121	S30 and (circuit adj board)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/28 09:17
S32	1428	(257/777).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/06/28 09:18
S33	766	(29/739).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/06/28 09:20
S34	932	(29/740).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/06/28 09:20
S35	658	(29/741).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/06/28 09:34
S36	1529	(circuit adj board) near laminate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/28 09:44
S37	12	S21 and S36	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/28 09:46
S38	2	S20 and S36	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/28 09:47
S39	1415	(438/118).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/06/28 09:47

JUB

S40	5	S39 and S36	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/28 09:47
S41	2	("4243788"   "4803022").PN. OR ("6599619").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/28 10:04
S42	77	bond\$4 near diode and (circuit adj board)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/29 06:44
S43	86	bond\$4 near resistor and (circuit adj board)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/29 06:51
S44	60	bond\$4 near transistor and (circuit adj board)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/29 07:16
S46	0	bond\$4 near transistor near (circuit adj board)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/29 07:16